

Features

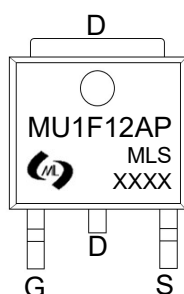
- High density cell design for ultra low $R_{DS(ON)}$
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high EAS

Product Summary

V_{DS}	$R_{DS(ON)}$ MAX	I_D MAX
-150V	345mΩ@-10V	-12A

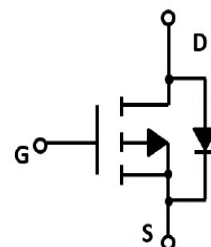
Application

- Battery and loading switching
- Excellent package for good heat dissipation



MU1F12AP: Device code
XXXX: Code

Marking and pin assignment



Schematic diagram



Halogen-Free

Absolute Maximum Ratings (TA=25°C unless otherwise noted)

Symbol	Parameter	Rating	Unit
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Common Ratings (TC=25°C Unless Otherwise Noted)

V_{DS}	Drain-Source Breakdown Voltage	-150	V
V_{GS}	Gate-Source Voltage	±20	V
T_J	Maximum Junction Temperature	150	°C
T_{STG}	Storage Temperature Range	-50 to 155	°C
I_S	Diode Continuous Forward Current	$T_C=25^{\circ}C$ -12	A

Mounted on Large Heat Sink

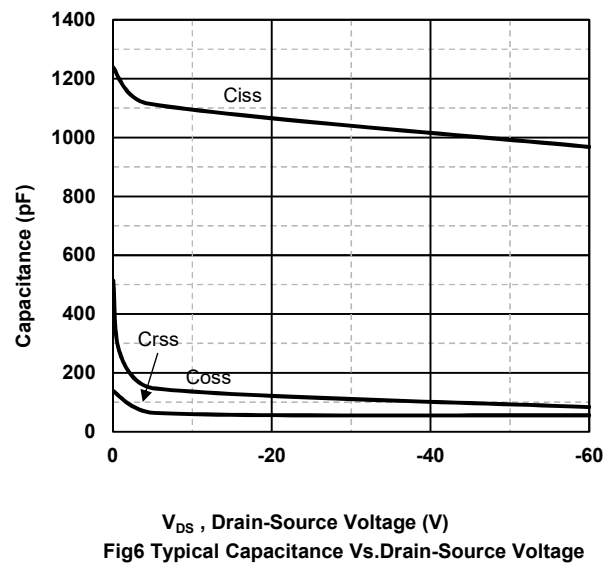
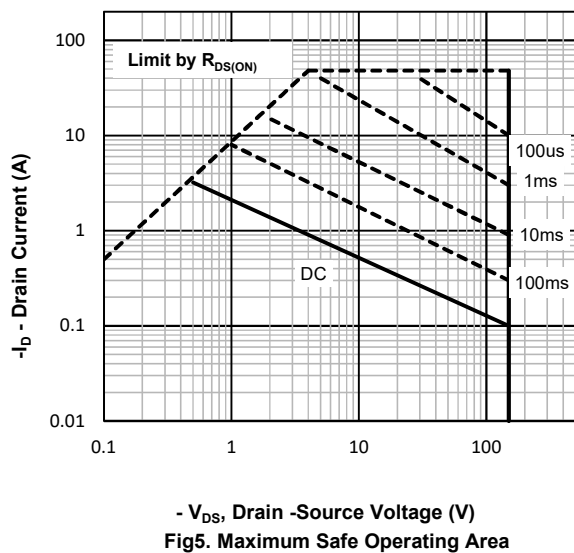
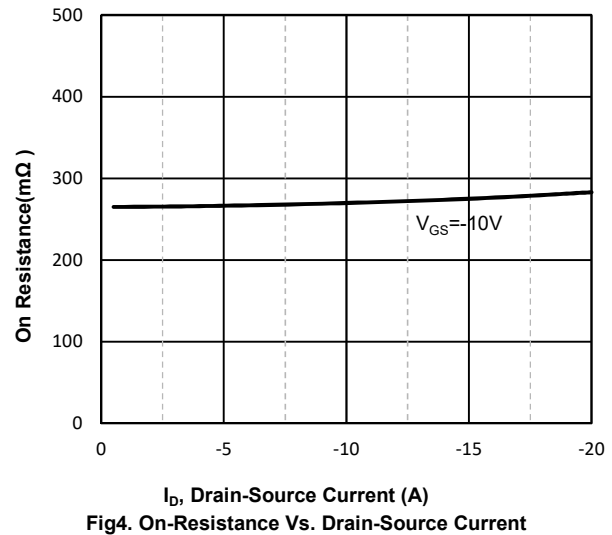
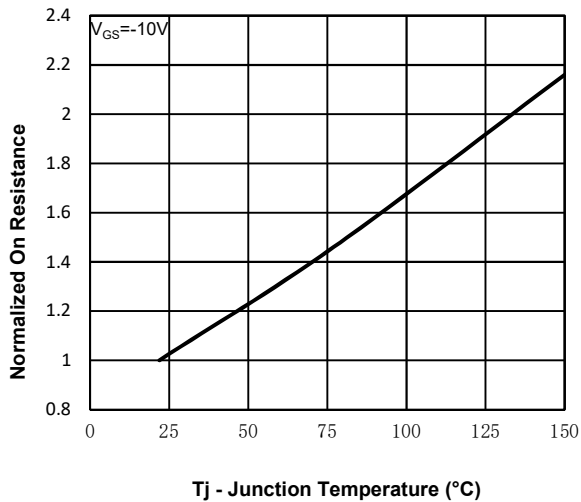
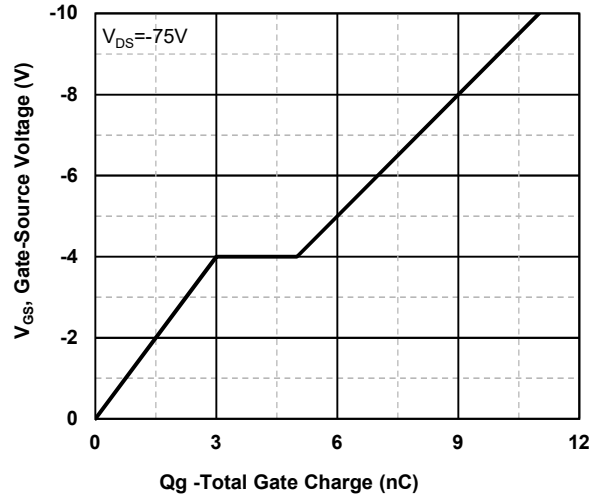
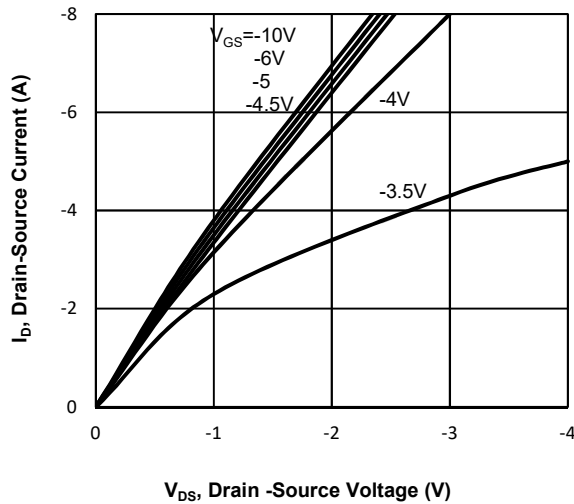
I_{DM}	Pulse Drain Current Tested	$T_C=25^{\circ}C$ -48	A
I_D	Continuous Drain Current	$T_C=25^{\circ}C$ -12	A
P_D	Maximum Power Dissipation	$T_C=25^{\circ}C$ 85	W
$R_{\theta JA}$	Thermal Resistance Junction-Ambient	35	°C/W

Ordering Information (Example)

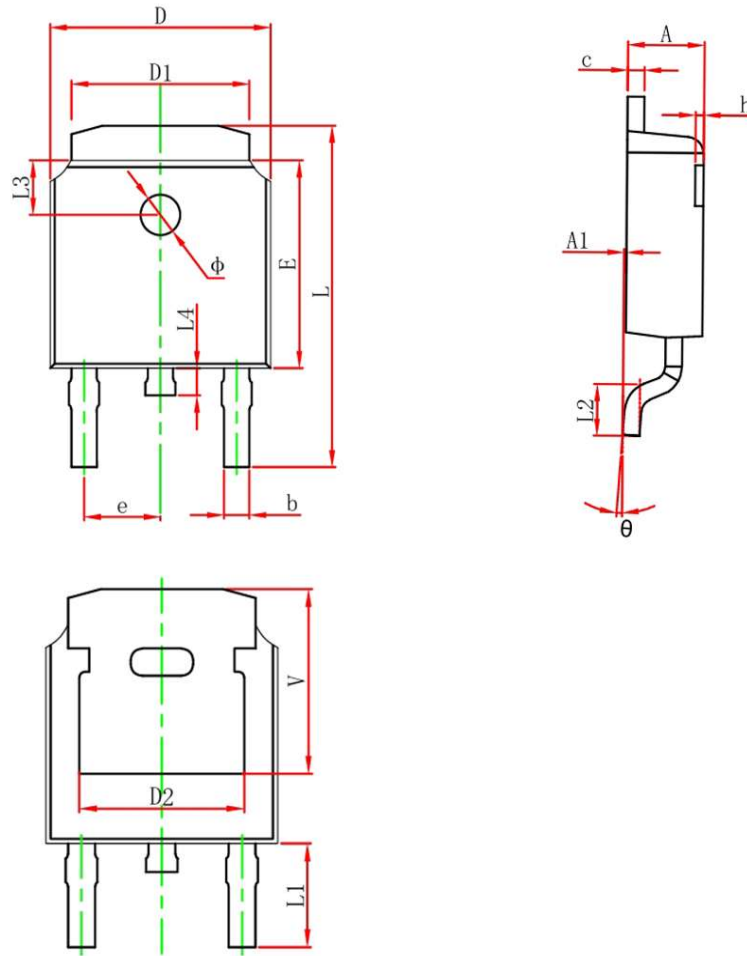
Type	Package	Marking	Minimum Package(pcs)	Inner Box Quantity(pcs)	Outer Carton Quantity(pcs)	Delivery Mode
MU1F12AP	TO-252	MU1F12AP	2,500	5,000	35,000	13"reel

Electrical Characteristics (TJ=25°C unless otherwise noted)						
Symbol	Parameter	Condition	Min	Typ	Max	Unit
Static Electrical Characteristics @ TJ = 25°C (unless otherwise stated)						
BV _{(BR)DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =-250μA	-150	--	--	V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =-150V, V _{GS} =0V	--	--	-1	μA
I _{GSS}	Gate-Body Leakage Current	V _{GS} =±20V, V _{DS} =0V	--	--	±100	nA
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =-250μA	-2.0	--	-4.0	V
R _{DS(on)}	Drain-Source On-State Resistance	V _{GS} =-10V, I _D =-12A	--	265	345	mΩ
Dynamic Electrical Characteristics @ TJ = 25°C (unless otherwise stated)						
C _{ISS}	Input Capacitance	V _{DS} =-50V, V _{GS} =0V, f=1MHz	--	953	--	pF
C _{OSS}	Output Capacitance		--	39	--	pF
C _{RSS}	Reverse Transfer Capacitance		--	24	--	pF
Switching Characteristics						
Q _g	Total Gate Charge	V _{DS} =-75V, I _D =-10A, V _{GS} =-10V	--	11	--	nC
Q _{gs}	Gate Source Charge		--	3.2	--	nC
Q _{gd}	Gate Drain Charge		--	1.9	--	nC
t _{d(on)}	Turn-on Delay Time	V _{DS} =-75V, I _D =-10A, V _{GS} =-10V, R _G =6Ω	--	9.7	--	nS
t _r	Turn-on Rise Time		--	2.5	--	nS
t _{d(off)}	Turn-Off Delay Time		--	17	--	nS
t _f	Turn-Off Fall Time		--	5.7	--	nS
Source- Drain Diode Characteristics						
V _{SD}	Forward on voltage	Tj=25°C, Is=-10A	--	--	-1.2	V

Typical Operating Characteristics



TO-252 Package information



Symbol	Dimensions in Millimeters(mm)		Dimensions In Inches	
	Min	Max	Min	Max
A	2.200	2.400	0.087	0.094
A1	0.000	0.127	0.000	0.005
b	0.635	0.770	0.025	0.030
c	0.450	0.580	0.018	0.023
D	6.500	6.700	0.256	0.264
D1	5.100	5.460	0.201	0.215
D2	4.830 REF.		0.190 REF.	
E	6.000	6.200	0.236	0.244
e	2.186	2.386	0.086	0.094
L	9.712	10.312	0.386	0.406
L1	2.900 REF.		0.114 REF.	
L2	1.400	1.700	0.055	0.067
L3	1.600 REF.		0.063 REF.	
L4	0.600	1.000	0.024	0.039
Φ	1.100	1.300	0.043	0.051
θ	0°	8°	0°	8°
h	0.000	0.300	0.000	0.012
V	5.250 REF.		0.207 REF.	